TOSHIBA Insulated Gate Bipolar Transistor Silicon N Channel IGBT

GT60N321

High Power Switching Applications Fourth Generation IGBT

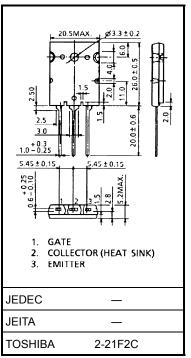
- FRD included between emitter and collector
- Enhancement mode type
- High speed IGBT : $t_f = 0.25 \ \mu s$ (typ.) (I_C = 60 A)

FRD : $t_{rr} = 0.8 \ \mu s$ (typ.) (di/dt = -20 A/ μs)

• Low saturation voltage: V_{CE} (sat) = 2.3 V (typ.) (I_C = 60 A)

Characteristic	symbol	Rating	Unit		
Collector-Emitter Voltage		VCES	1000	V	
Gate-Emitter Voltage	V _{GES}	±25	V		
Collector Current	DC	IC	60	A	
	1 ms	I _{CP}	120		
Emitter-Collector Forward Current	DC	IECF	15	A	
	1 ms	I _{ECFP}	120		
Collector Power Dissipation (Tc = 25°C)		PC	170	W	
Junction Temperature		Тј	150	°C	
Storage Temperature		T _{stg}	-55~150	°C	
Screw Torque		_	0.8	N∙m	

Absolute Maximum Ratings (Ta = 25°C)

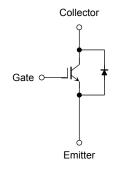


Weight: 9.75 g (typ.)

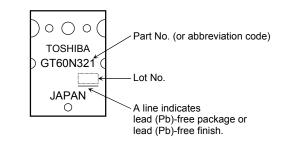
Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/Derating Concept and Methods) and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Equivalent Circuit



Marking

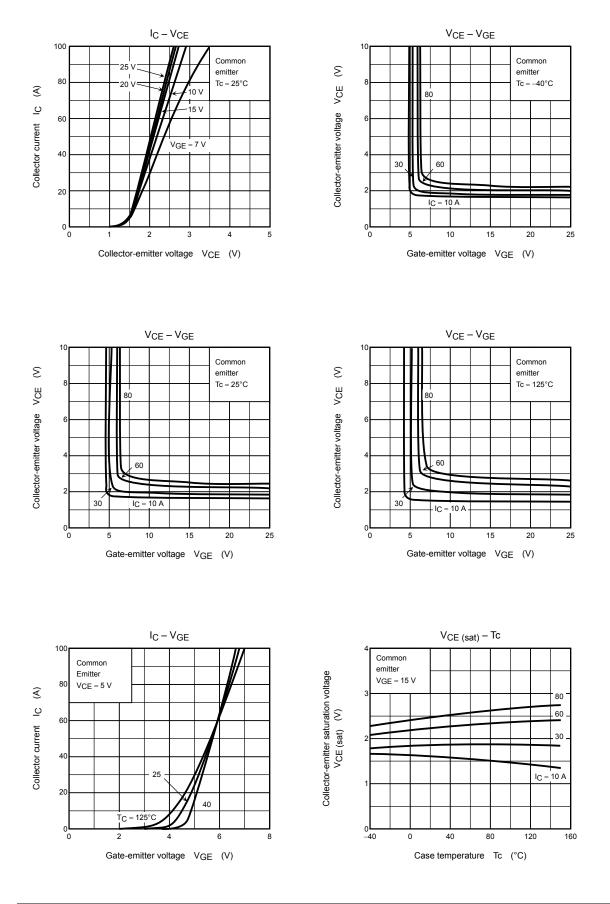


Unit: mm

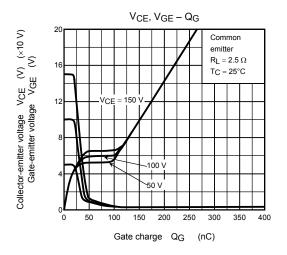
Electrical Characteristics (Ta = 25°C)

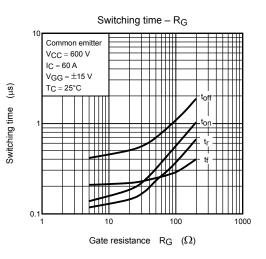
Characteristic		Symbol	Test Condition	Min	Тур.	Max	Unit
Gate Leakage Current		I _{GES}	$V_{GE} = \pm 25 \text{ V}, \text{ V}_{CE} = 0$	_		±500	nA
Collector Cut-off Current		ICES	$V_{CE} = 1000 V, V_{GE} = 0$	_		1.0	mA
Gate-Emitter Cut-off Voltage		V _{GE (OFF)}	$I_{C} = 60 \text{ mA}, V_{CE} = 5 \text{ V}$	3.0	_	6.0	V
Collector-Emitter Saturation Voltage		V _{CE (sat)} (1)	$I_{C} = 10 \text{ A}, V_{GE} = 15 \text{ V}$	_	1.6	2.3	V
Collector-Emitter Saturation Voltage		V _{CE (sat)} (2)	$I_{C} = 60 \text{ A}, V_{GE} = 15 \text{ V}$	_	2.3	2.8	V
Input Capacitance		C _{ies}	V_{CE} = 10 V, V_{GE} = 0, f = 1 MHz	_	4000	_	pF
Switching Time	Rise Time	tr	$ \begin{array}{c} 51 \Omega \\ 600 V \end{array} $	_	0.23	_	μs
	Turn-on Time	t _{on}			0.33		
	Fall Time	t _f			0.25	0.40	
	Turn-off Time	t _{off}			0.70		
Emitter-Collector Forward Voltage		V _{ECF}	$I_{EC} = 15 \text{ A}, \text{ V}_{GE} = 0$	_	1.5	2.0	V
Reverse Recovery Time t _{rr}		t _{rr}	$I_F = 15 \text{ A}, V_{GE} = 0, \text{ di/dt} = -20 \text{ A/}\mu\text{s}$	_	0.8	2.5	μS
Thermal Resistance		R _{th(j-c)}				0.74	°C/W
Thermal Resistance		R _{th(j-c)}				4.0	°C/W

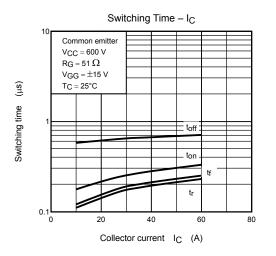
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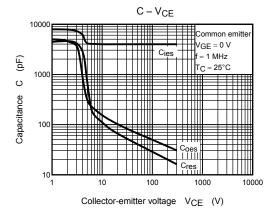


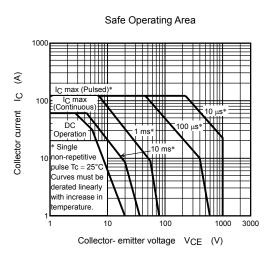
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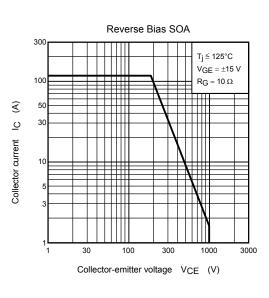




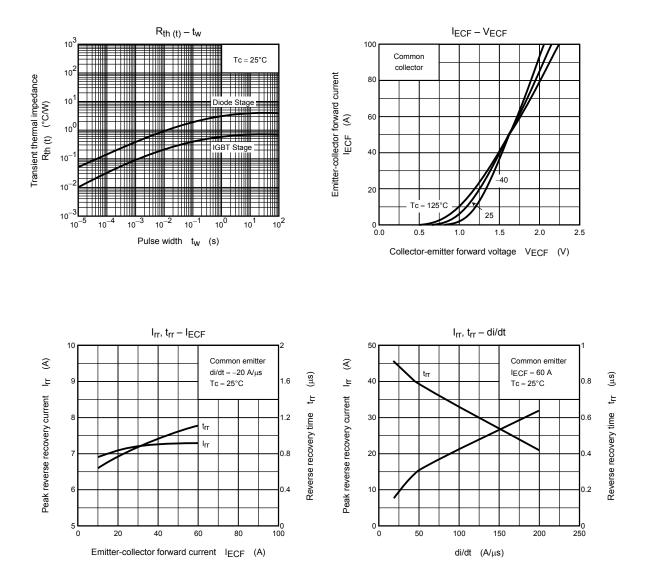








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